2-Channel Headset/Speaker EMI Filter Array with ESD Protection

Product Description

The CM1411 is a dual, low-pass filter array integrating two pi-style filters (C-R-C) that reduce EMI/RFI emissions while providing ESD protection. This part is custom-designed to interface with a speaker port on a cellular telephone or similar device. Each high quality filter provides more than 35 dB attenuation in the 800 to 2700 MHz range. These pi-style filters support bidirectional filtering that control EMI both to and from a speaker element. They also support AC signals with a cutoff frequency of 31 MHz, enabling audio signals to pass through without distortion.

In addition, the CM1411 provides a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The CM1411 can safely dissipate ESD strikes of ± 8 kV, the maximum requirement of the IEC 61000–4–2 international standard. Using the MIL–STD–883 (Method 3015) specification for Human Body Model (HBM) ESD, the device provides protection for contact discharges to greater than ± 15 kV.

The CM1411 is particularly well-suited for portable electronics (e.g., cellular telephones, PDAs, notebook computers) because of its small package format and low weight. The CM1411 incorporates *OptiGuard*^M coating which results in improved reliability at assembly and is available in a space-saving, low-profile Chip Scale Package with lead-free finishing.

Features

- Functionally and Pin Compatible with the CSPEMI201A
- *OptiGuard*[™] Coated for Improved Reliability at Assembly
- Two Channels of EMI Filtering
- Pi-Style EMI Filters in a Capacitor-Resistor-Capacitor (C-R-C) Network
- Greater than 40 dB Attenuation at 1 GHz
- ±8 kV ESD Protection on Each Channel (IEC 61000-4-2 Level 4, Contact Discharge)
- ±15 kV ESD Protection in Each Channel (HBM)
- Supports AC Signals-Ideal for Audio Applications
- Extremely Low Lead Inductance for Optimum Filter and ESD Performance
- 5-Bump, 0.950 mm X 1.410 mm Footprint Chip Scale Package (CSP)
- These Devices are Pb-Free and are RoHS Compliant

Applications

- EMI Filtering and ESD Protection for Headset/Speaker Ports
- Wireless Handsets
- Handheld PCs/PDAs



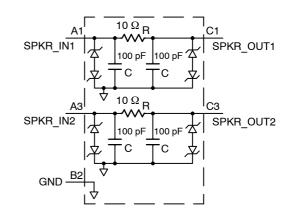
ON Semiconductor®

http://onsemi.com



CP SUFFIX CASE 567AZ

BLOCK DIAGRAM



MARKING DIAGRAM



CA = CM1411-03CP

ORDERING INFORMATION

Device	Package	Shipping [†]
CM1411-03CP	WLCSP5	3500/Tape & Reel
	(Pb-Free)	

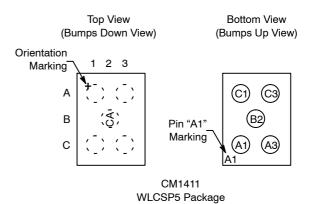
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

- MP3 Players
- Digital Camcorders
- Notebooks
- Desktop PCs

Table 1. PIN DESCRIPTIONS

ſ	Pin	Name	Description	
	A1	SPKR_IN1	Speaker Input 1 (from Audio Circuitry)	
	A3	A3 SPKR_IN2 Speaker Input 2 (from Audio Circu		
Ī	B2	GND	Device Ground	
Ī	C1	SPKR_OUT1	Speaker Output 1 (to Speaker)	
	C3	SPKR_OUT2	Speaker Output 2 (to Speaker)	

PACKAGE / PINOUT DIAGRAMS



SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units
Storage Temperature Range	-65 to +150	°C
DC Power per Resistor	100	mW
DC Package Power Rating	200	mW

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. STANDARD OPERATING CONDITIONS

Parameter	Rating	Units
Operating Temperature Range	-40 to +85	°C

Table 4. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
R	Resistance		9	10	11	Ω
R _{MATCH}	Resistance Matching				5	%
С	Capacitance		80	100	120	pF
I _{LEAK}	Diode Leakage Current	V _{IN} = 5.0 V			1.0	μA
V _{SIG}	Signal Voltage Positive Clamp Negative Clamp	I _{LOAD} = 10 mA	5 –15	7 -10	15 -5	V
V _{ESD}	In-system ESD Withstand Voltage a) Human Body Model, MIL-STD-883, Method 3015 b) Contact Discharge per IEC 61000-4-2 Level 4	(Notes 2 and 4)	±15 ±8			kV
V _{CL}	Clamping Voltage during ESD Discharge MIL-STD-883 (Method 3015), 8 kV Positive Transients Negative Transients	(Notes 2, 3 and 4)		+15 -19		V
f _C	Cut–Off Frequency, Z_{SOURCE} = 50 Ω , Z_{LOAD} = 50 Ω	R = 10 Ω, C = 100 pF		31		MHz

1. $T_A = 25^{\circ}C$ unless otherwise specified.

2. ESD applied to input and output pins with respect to GND, one at a time.

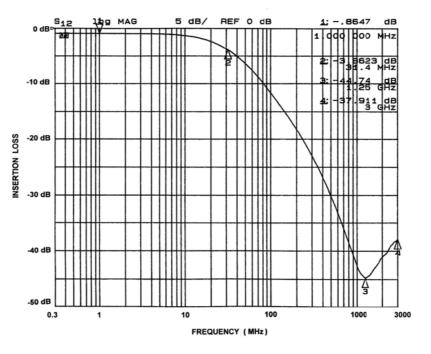
3. Clamping voltage is measured at the opposite side of the EMI filter to the ESD pin. For example, if ESD is applied to Pin A1, then clamping voltage is measured at Pin C1.

4. Unused pins are left open.

CM1411

PERFORMANCE INFORMATION

Typical Filter Performance (nominal conditions unless specified otherwise, 50 Ω Environment)





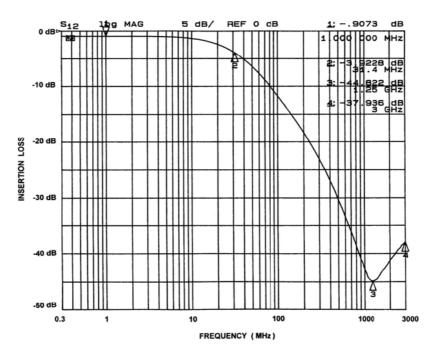
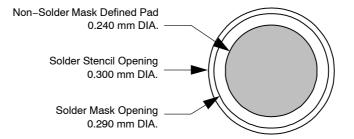


Figure 2. Insertion Loss vs. Frequency (A3–C3 to GND B2)

CM1411

APPLICATION INFORMATION

Parameter	Value	
Pad Size on PCB	0.240 mm	
Pad Shape	Round	
Pad Definition	Non-Solder Mask defined pads	
Solder Mask Opening	0.290 mm Round	
Solder Stencil Thickness	0.125 mm – 0.150 mm	
Solder Stencil Aperture Opening (laser cut, 5% tapered walls)	0.300 mm Round	
Solder Flux Ratio	50/50 by volume	
Solder Paste Type	No Clean	
Pad Protective Finish	OSP (Entek Cu Plus 106A)	
Tolerance – Edge To Corner Ball	±50 μm	
Solder Ball Side Coplanarity	±20 μm	
Maximum Dwell Time Above Liquidous	60 seconds	
Maximum Soldering Temperature for Lead-free Devices using a Lead-free Solder Paste	260°C	





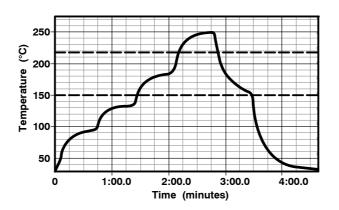
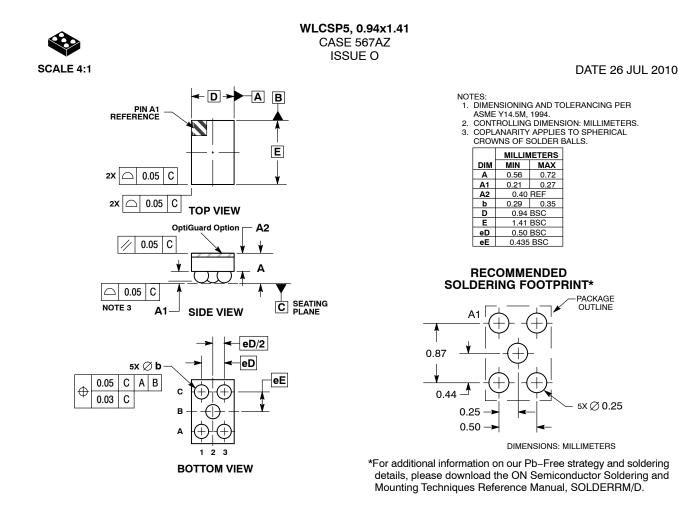


Figure 4. Lead-free (SnAgCu) Solder Ball Reflow Profile

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